

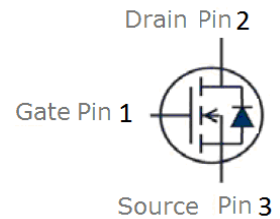
Features

- N-Channel, 10V Logic Level Control
- Enhancement mode
- Very low on-resistance $R_{DS(on)}$ @ $V_{GS}=10V$
- 100% Avalanche test
- Pb-free lead plating; RoHS compliant



Part ID	Package Type	Marking	Tape and reel information
VS150N08BN	TO-262	150N08BN	50PCS/Tube

V_{DS}	80	V
$R_{DS(on),TYP} @ V_{GS}=10V$	4.5	m Ω
I_D	155	A

TO-262


Maximum ratings, at $T_j=25^\circ\text{C}$, unless otherwise specified

Symbol	Parameter	Rating	Unit
$V_{(BR)DSS}$	Drain-Source breakdown voltage	80	V
I_S	Diode continuous forward current	$T_C=25^\circ\text{C}$ 155	A
I_D	Continuous drain current @ $V_{GS}=10V$	$T_C=25^\circ\text{C}$ 155	A
		$T_C=100^\circ\text{C}$ 109	A
I_{DM}	Pulse drain current tested ①	$T_C=25^\circ\text{C}$ 620	A
EAS	Avalanche energy, single pulsed ②	823	mJ
P_D	Maximum power dissipation	$T_C=25^\circ\text{C}$ 259	W
V_{GS}	Gate-Source voltage	± 25	V
$T_{STG} T_J$	Storage and operating temperature range	-55 to 175	$^\circ\text{C}$

Thermal Characteristics

Symbol	Parameter	Typical	Unit
$R_{\theta JC}$	Thermal Resistance-Junction to Case	0.58	$^\circ\text{C/W}$
$R_{\theta JA}$	Thermal Resistance-Junction to Ambient	62.5	$^\circ\text{C/W}$

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
Static Electrical Characteristics @ $T_j = 25^\circ\text{C}$ (unless otherwise stated)						
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	80	--	--	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=80V, V_{GS}=0V$	--	--	1	μA
	Zero Gate Voltage Drain Current($T_j=125^\circ\text{C}$)	$V_{DS}=80V, V_{GS}=0V$	--	--	100	μA
I_{GSS}	Gate-Body Leakage Current	$V_{GS}=\pm 25V, V_{DS}=0V$	--	--	± 100	nA
$V_{GS(TH)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	2.0	3.0	4.0	V
$R_{DS(ON)}$	Drain-Source On-State Resistance ^③	$V_{GS}=10V, I_D=80A$	--	4.5	6	m Ω
Dynamic Electrical Characteristics @ $T_j = 25^\circ\text{C}$ (unless otherwise stated)						
C_{iss}	Input Capacitance	$V_{DS}=30V, V_{GS}=0V,$ $f=1\text{MHz}$	--	4115	--	pF
C_{oss}	Output Capacitance		--	570	--	pF
C_{riss}	Reverse Transfer Capacitance		--	395	--	pF
R_g	Gate Resistance	$f=1\text{MHz}$	--	2.6	--	Ω
Q_g	Total Gate Charge	$V_{DS}=40V, I_D=80A,$ $V_{GS}=10V$	--	69	--	nC
Q_{gs}	Gate-Source Charge		--	23	--	nC
Q_{gd}	Gate-Drain Charge		--	22	--	nC
Switching Characteristics						
$t_{d(on)}$	Turn-on Delay Time	$V_{DD}=40V,$ $I_D=80A,$ $R_G=3\Omega,$ $V_{GS}=10V$	--	28	--	nS
t_r	Turn-on Rise Time		--	20	--	nS
$t_{d(off)}$	Turn-Off Delay Time		--	50	--	nS
t_f	Turn-Off Fall Time		--	23	--	nS
Source- Drain Diode Characteristics @ $T_j = 25^\circ\text{C}$ (unless otherwise stated)						
V_{SD}	Forward on voltage	$I_{SD}=80A, V_{GS}=0V$	--	0.9	1.2	V
t_{rr}	Reverse Recovery Time	$T_j=25^\circ\text{C}, I_{sd}=80A,$ $V_{GS}=0V$ $di/dt=500A/\mu s$	--	28	--	nS
Q_{rr}	Reverse Recovery Charge		--	110	--	nC

NOTE:

- ① Repetitive rating; pulse width limited by max. junction temperature.
- ② Limited by T_{jmax} , starting $T_j = 25^\circ\text{C}$, $L = 0.5\text{mH}, R_G = 25\Omega, I_{AS} = 45A, V_{GS} = 10V$. Part not recommended for use above this value
- ③ Pulse width $\leq 300\mu s$; duty cycle $\leq 2\%$.

Typical Characteristics

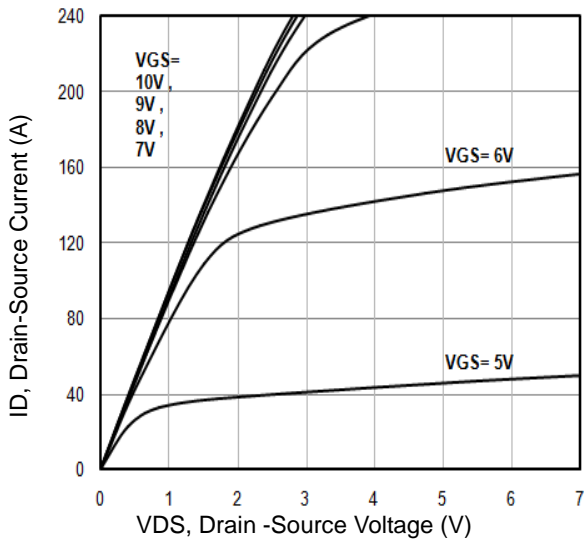


Fig1. Typical Output Characteristics

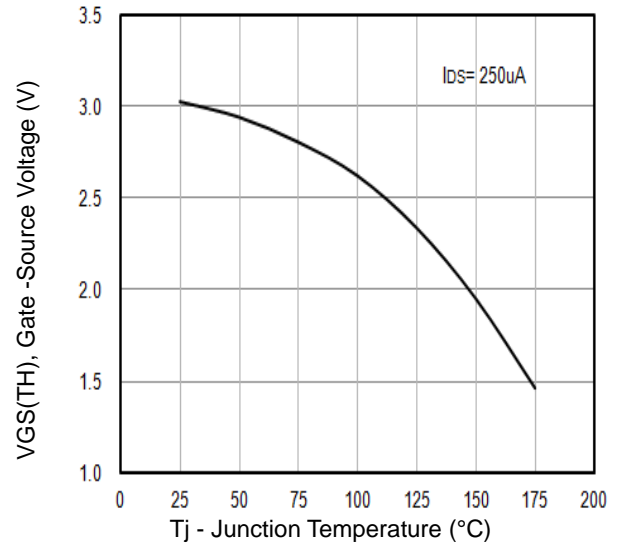


Fig2. $V_{GS(TH)}$ Gate -Source Voltage Vs. T_j

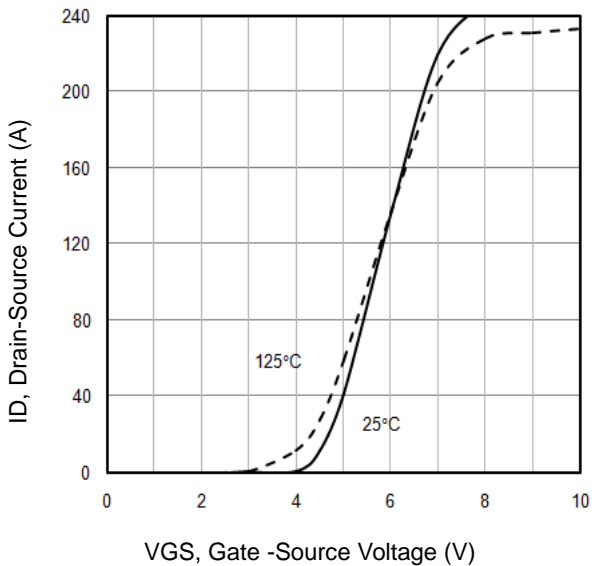


Fig3. Typical Transfer Characteristics

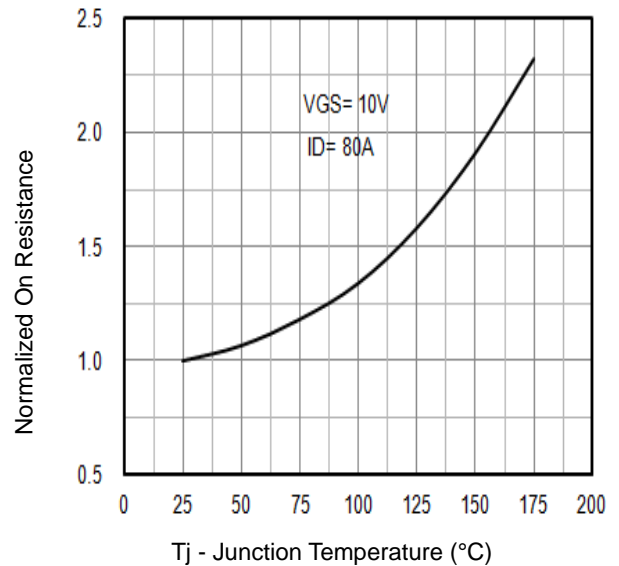


Fig4. Normalized On-Resistance Vs. Temperature

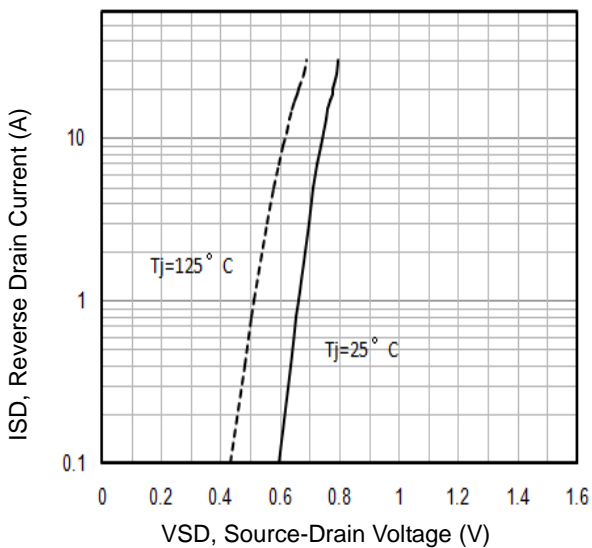


Fig5. Typical Source-Drain Diode Forward Voltage

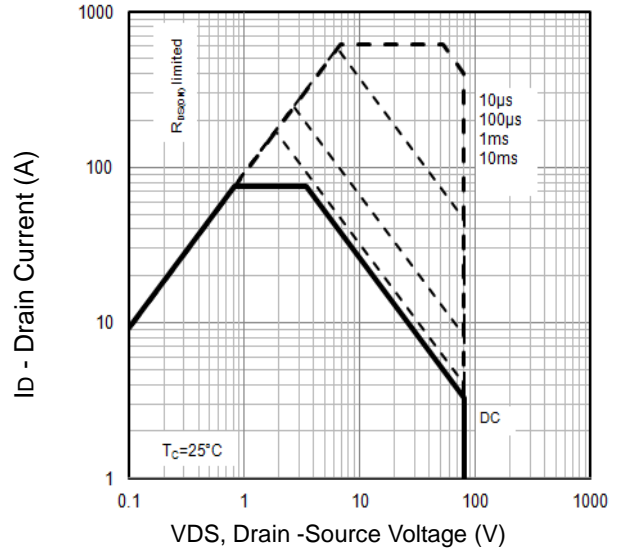


Fig6. Maximum Safe Operating Area

Typical Characteristics

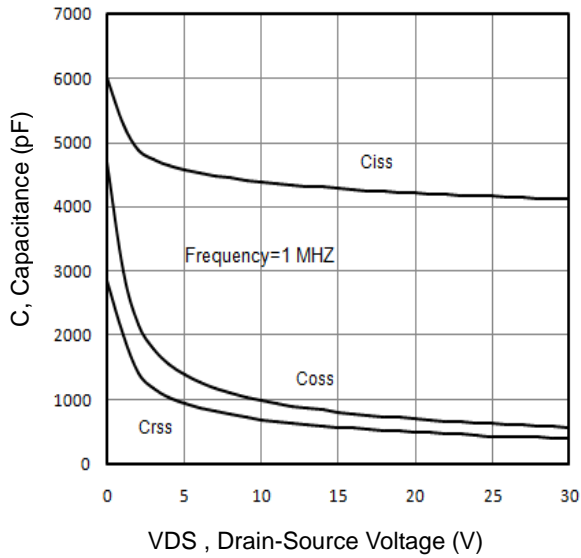


Fig7. Typical Capacitance Vs.Drain-Source Voltage

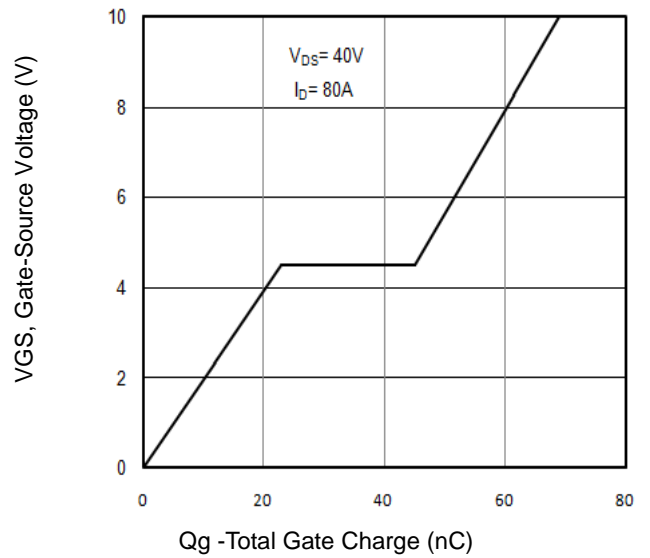


Fig8. Typical Gate Charge Vs.Gate-Source Voltage

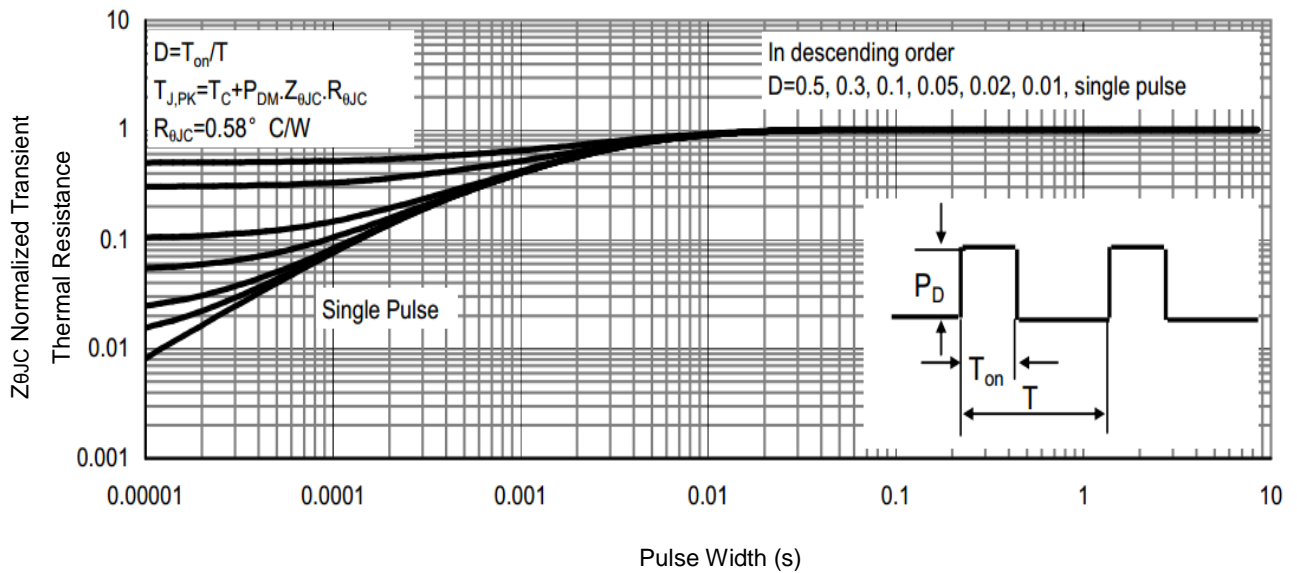


Fig9. Normalized Maximum Transient Thermal Impedance

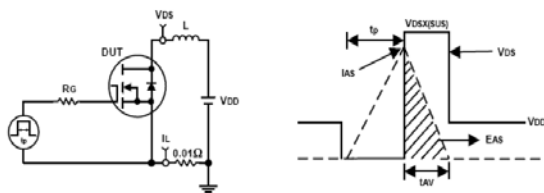


Fig10. Unclamped Inductive Test Circuit and waveforms

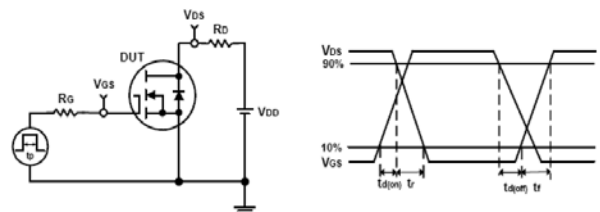
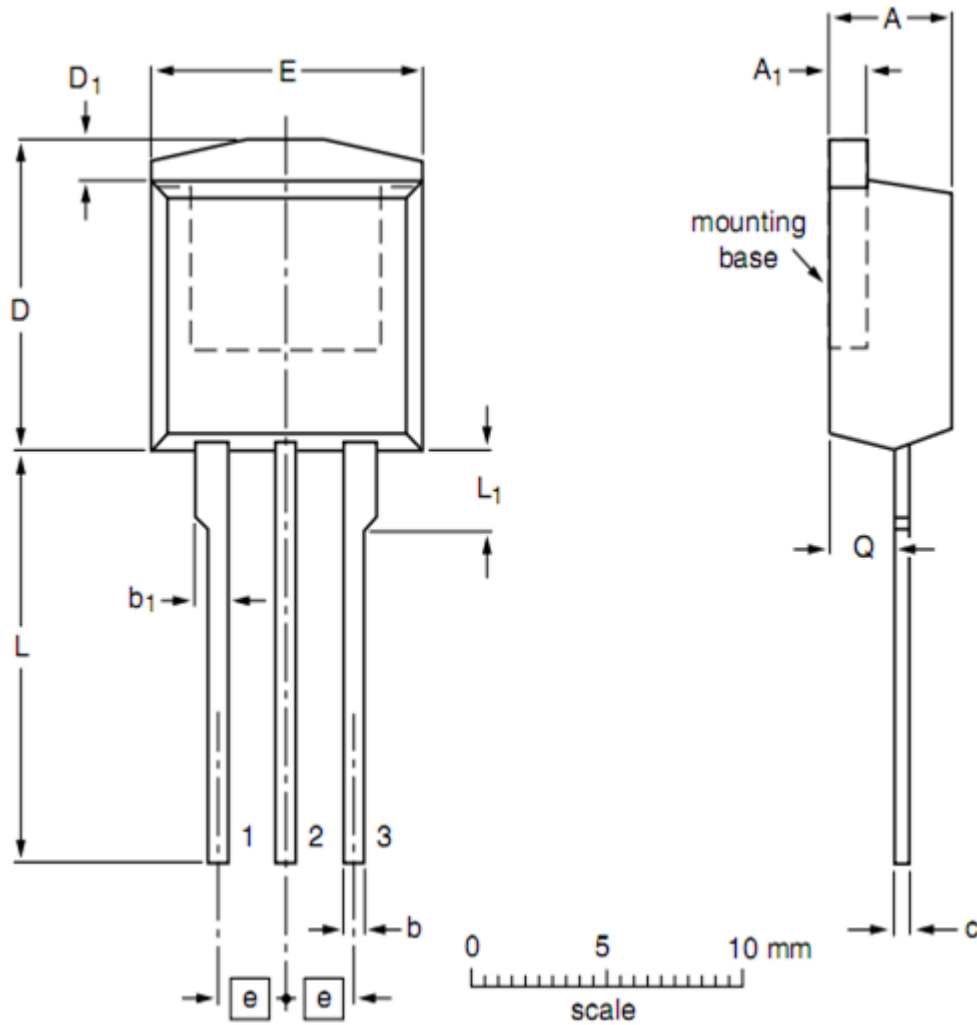


Fig11. Switching Time Test Circuit and waveforms

TO-262 Package Outline Data



Symbol	Dimensions (unit: mm)		
	Min	Typ	Max
A	4.10	4.47	4.83
A ₁	1.15	1.28	1.40
b	0.70	0.85	0.99
b ₁	1.20	1.30	1.40
c	0.46	0.58	0.70
D	9.80	10.40	11.00
D ₁	1.00	1.20	1.40
E	9.70	10.00	10.29
e	--	2.54	--
L	12.75	13.73	14.70
L ₁	--	3.10	3.30
Q	2.10	2.40	2.70

Note:

1. Refer to JEDEC TO-262.

Customer Service

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